

## 8A, 400V - 1000V Surface Mount Rectifier

### FEATURES

- Glass passivated chip junction
- Low forward voltage drop
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

### MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.270g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_F$	8	A
$V_{RRM}$	400 - 1000	V
$I_{FSM}$	200	A
$T_{J\ MAX}$	150	°C
Package	DO-214AB (SMC)	
Configuration	Single die	



DO-214AB (SMC)



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	S8GC	S8JC	S8KC	S8MC	UNIT
Marking code on the device		S8GC	S8JC	S8KC	S8MC	
Repetitive peak reverse voltage	$V_{RRM}$	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	280	420	560	700	V
Forward current	$I_F$	8				A
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	$T_J = 25^\circ\text{C}$	200				A
	$T_J = 125^\circ\text{C}$					170
Surge peak forward current, 1.0ms single half sine-wave superimposed on rated load	$T_J = 25^\circ\text{C}$	600				A
	$T_J = 125^\circ\text{C}$					338
Junction temperature	$T_J$	- 55 to +150				°C
Storage temperature	$T_{STG}$	- 55 to +150				°C

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	12.5	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	44.0	°C/W

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)					
<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
Forward voltage <sup>(1)</sup>	$I_F = 8\text{A}, T_J = 25^\circ\text{C}$	$V_F$	-	0.985	V
Reverse current @ rated $V_R$ <sup>(2)</sup>	$T_J = 25^\circ\text{C}$	$I_R$	-	10	$\mu\text{A}$
	$T_J = 125^\circ\text{C}$		-	250	$\mu\text{A}$
Junction capacitance	1MHz, $V_R = 4.0\text{V}$	$C_J$	48	-	pF

**Notes:**

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

<b>ORDERING INFORMATION</b>		
<b>ORDERING CODE<sup>(1)</sup></b>	<b>PACKAGE</b>	<b>PACKING</b>
S8xC	DO-214AB (SMC)	3,000 / Tape & Reel

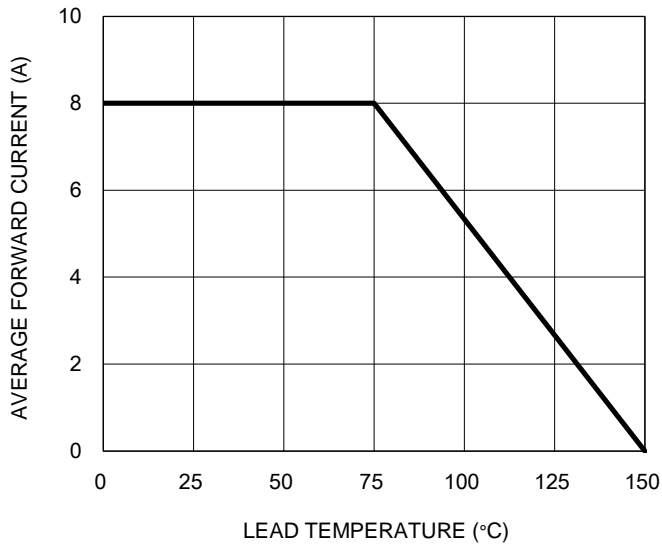
**Notes:**

1. "x" defines voltage from 400V(S8GC) to 1000V(S8MC)

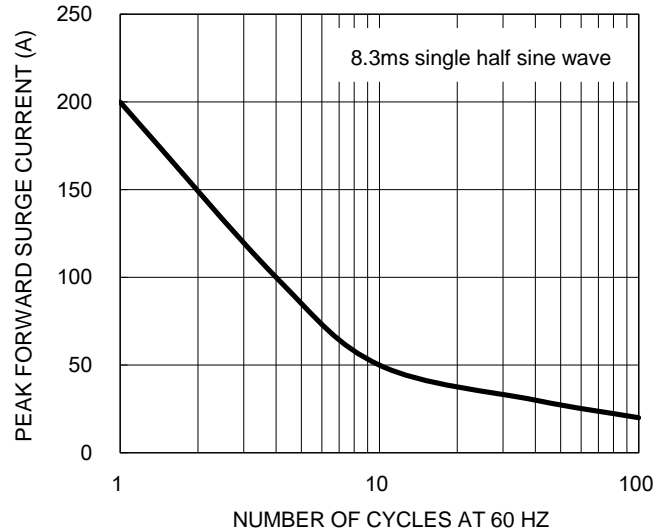
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

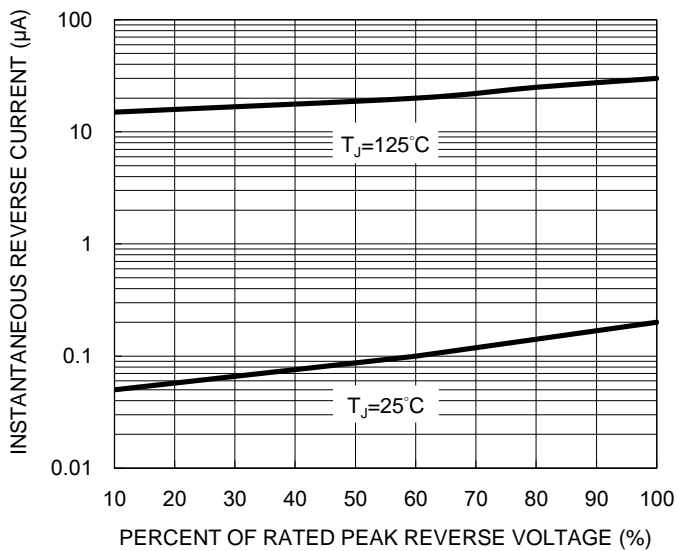
**Fig.1 Forward Current Derating Curve**



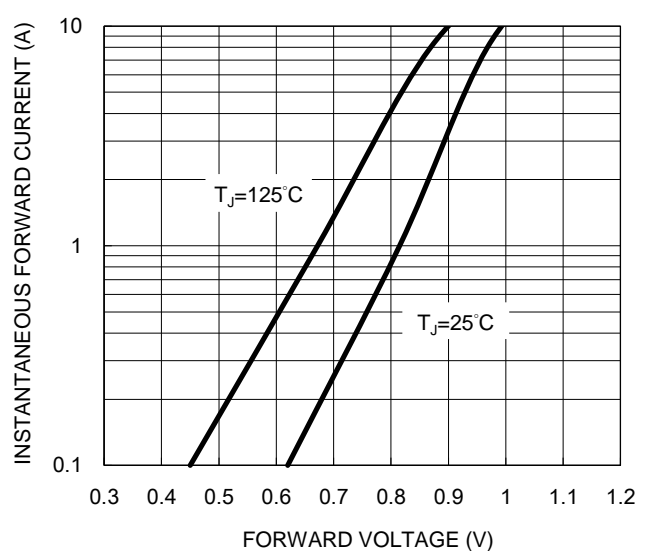
**Fig.2 Maximum Non-repetitive Forward Surge Current**



**Fig.3 Typical Reverse Characteristics**

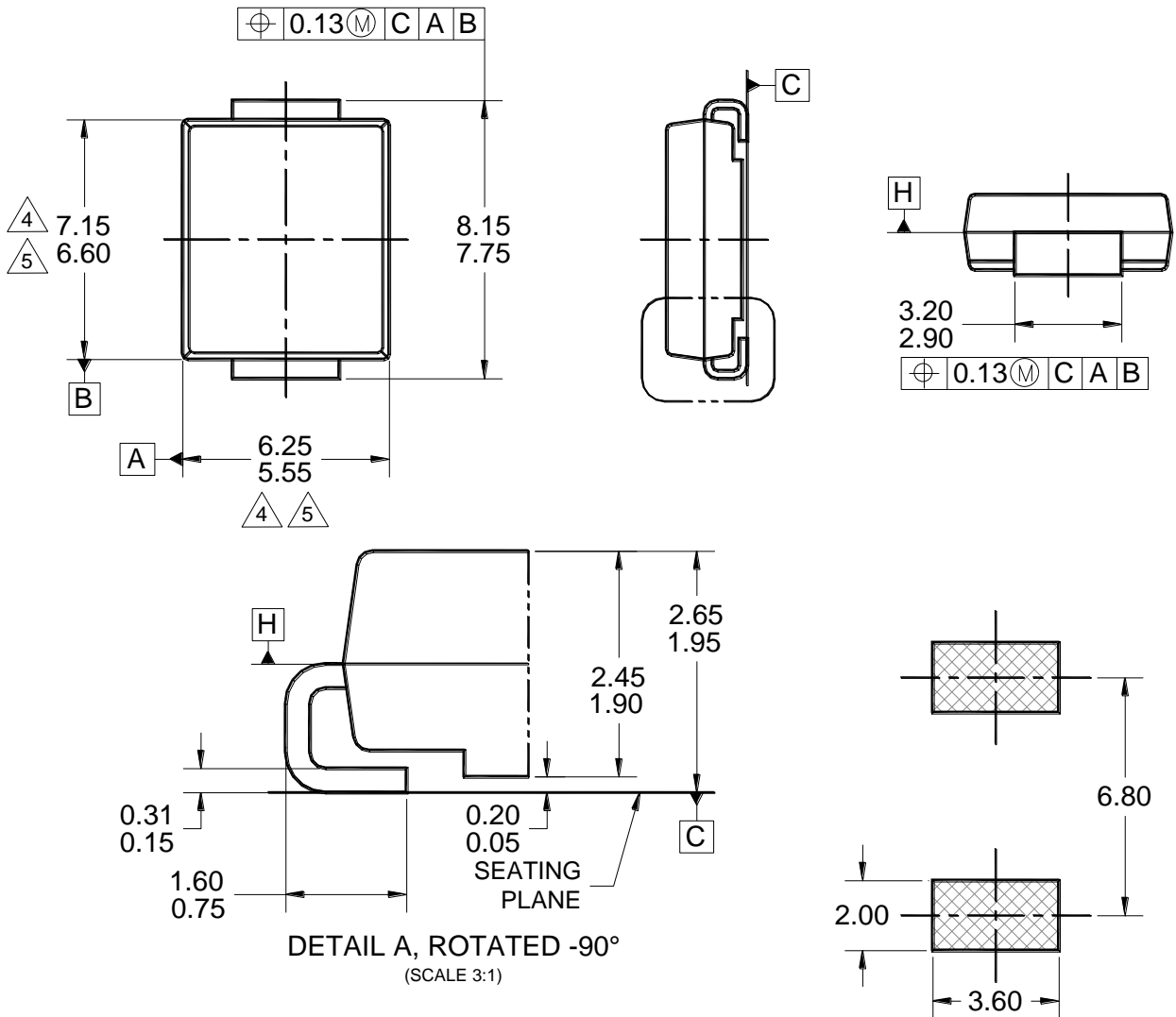


**Fig.4 Typical Forward Characteristics**

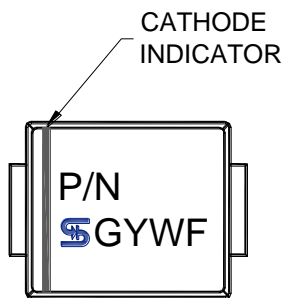


**PACKAGE OUTLINE DIMENSIONS**

**DO-214AB (SMC)**



**SUGGESTED PAD LAYOUT**



**MARKING DIAGRAM**

P/N = MARKING CODE  
 G = GREEN COMPOUND  
 YW = DATE CODE  
 F = FACTORY CODE

**NOTES: UNLESS OTHERWISE SPECIFIED**

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.

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